



**THE DATASHEET OF
AT27BV256-90JI**



Features

- Fast Read Access Time - 70 ns
- Dual Voltage Range Operation
 - Unregulated Battery Power Supply Range, 2.7V to 3.6V
 - or Standard 5V \pm 10% Supply Range
- Pin Compatible with JEDEC Standard AT27C256R
- Low Power CMOS Operation
 - 20 μ A max. (less than 1 μ A typical) Standby for $V_{CC} = 3.6V$
 - 29 mW max. Active at 5 MHz for $V_{CC} = 3.6V$
- JEDEC Standard Surface Mount Packages
 - 32-Lead PLCC
 - 28-Lead 330-mil SOIC
 - 28-Lead TSOP
- High Reliability CMOS Technology
 - 2,000V ESD Protection
 - 200 mA Latchup Immunity
- Rapid™ Programming Algorithm - 100 μ s/byte (typical)
- CMOS and TTL Compatible Inputs and Outputs
 - JEDEC Standard for LVTTTL and LVBO
- Integrated Product Identification Code
- Commercial and Industrial Temperature Ranges

Description

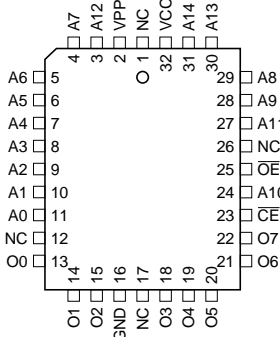
The AT27BV256 is a high performance, low power, low voltage 262,144-bit one-time programmable read only memory (OTP EPROM) organized as 32K by 8 bits. It requires only one supply in the range of 2.7V to 3.6V in normal read mode operation, making it ideal for fast, portable systems using either regulated or unregulated battery power.

(continued)

Pin Configurations

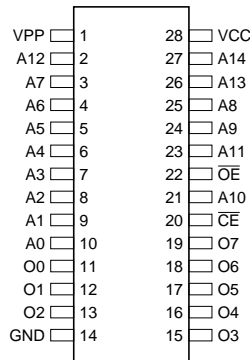
| Pin Name | Function |
|-----------------|---------------|
| A0 - A14 | Addresses |
| O0 - O7 | Outputs |
| \overline{CE} | Chip Enable |
| \overline{OE} | Output Enable |
| NC | No Connect |

PLCC Top View



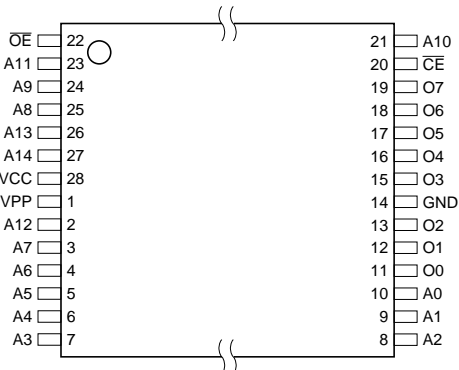
Note: PLCC package pins 1 and 17 are DON'T CONNECT.

SOIC Top View



TSOP Top View

Type 1



256K (32K x 8)
Unregulated
Battery-Voltage™
High Speed
OTP EPROM

AT27BV256



Atmel's innovative design techniques provide fast speeds that rival 5V parts while keeping the low power consumption of a 3V supply. At $V_{CC} = 2.7V$, any word can be accessed in less than 70 ns. With a typical power dissipation of only 18 mW at 5 MHz and $V_{CC} = 3V$, the AT27BV256 consumes less than one fifth the power of a standard 5V EPROM.

Standby mode supply current is typically less than $1 \mu A$ at 3V. The AT27BV256 simplifies system design and stretches battery lifetime even further by eliminating the need for power supply regulation.

The AT27BV256 is available in industry standard JEDEC-approved one-time programmable (OTP) plastic PLCC, SOIC and TSOP packages. All devices feature two-line control (\overline{CE} , \overline{OE}) to give designers the flexibility to prevent bus contention.

The AT27BV256 operating with V_{CC} at 3.0V produces TTL level outputs that are compatible with standard TTL logic devices operating at $V_{CC} = 5.0V$. At $V_{CC} = 2.7V$, the part is compatible with JEDEC approved low voltage battery operation (LVBO) interface specifications. The device is also capable of standard 5-volt operation making it ideally suited for dual supply range systems or card products that are pluggable in both 3-volt and 5-volt hosts.

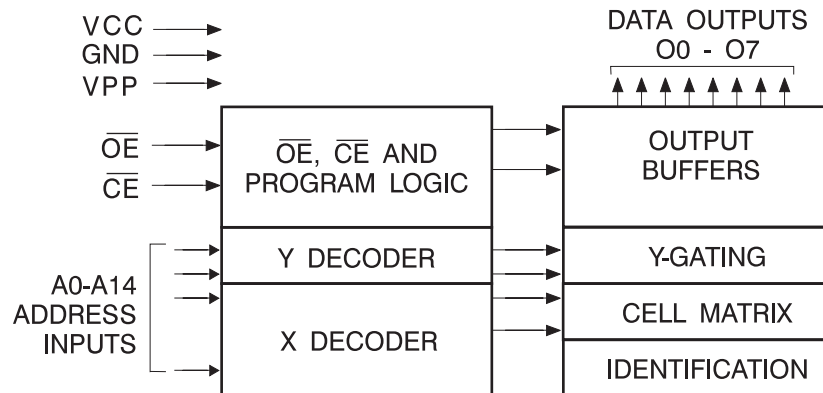
Atmel's AT27BV256 has additional features to ensure high quality and efficient production use. The Rapid™ Program-

ming Algorithm reduces the time required to program the part and guarantees reliable programming. Programming time is typically only 100 μs /byte. The Integrated Product Identification Code electronically identifies the device and manufacturer. This feature is used by industry standard programming equipment to select the proper programming algorithms and voltages. The AT27BV256 programs exactly the same way as a standard 5V AT27C256R and uses the same programming equipment.

System Considerations

Switching between active and standby conditions via the Chip Enable pin may produce transient voltage excursions. Unless accommodated by the system design, these transients may exceed data sheet limits, resulting in device non-conformance. At a minimum, a 0.1 μF high frequency, low inherent inductance, ceramic capacitor should be utilized for each device. This capacitor should be connected between the V_{CC} and Ground terminals of the device, as close to the device as possible. Additionally, to stabilize the supply voltage level on printed circuit boards with large EPROM arrays, a 4.7 μF bulk electrolytic capacitor should be utilized, again connected between the V_{CC} and Ground terminals. This capacitor should be positioned as close as possible to the point where the power supply is connected to the array.

Block Diagram



Absolute Maximum Ratings*

| | |
|--|--------------------------------|
| Temperature Under Bias | -40°C to +85°C |
| Storage Temperature | -65°C to +125°C |
| Voltage on Any Pin with Respect to Ground | -2.0V to +7.0V ⁽¹⁾ |
| Voltage on A9 with Respect to Ground | -2.0V to +14.0V ⁽¹⁾ |
| V _{PP} Supply Voltage with Respect to Ground | -2.0V to +14.0V ⁽¹⁾ |

*NOTICE: Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability

Note: 1. Minimum voltage is -0.6V dc which may undershoot to -2.0V for pulses of less than 20 ns. Maximum output pin voltage is V_{CC} + 0.75V dc which may be exceeded if certain precautions are observed (consult application notes) and which may overshoot to +7.0V for pulses of less than 20 ns.

Operating Modes

| Mode \ Pin | \overline{CE} | \overline{OE} | Ai | V _{PP} | V _{CC} | Outputs |
|--|-----------------|-----------------|---|-----------------|--------------------------------|---------------------|
| Read ⁽²⁾ | V _{IL} | V _{IL} | Ai | V _{CC} | V _{CC} ⁽²⁾ | D _{OUT} |
| Output Disable ⁽²⁾ | V _{IL} | V _{IH} | X ⁽¹⁾ | V _{CC} | V _{CC} ⁽²⁾ | High Z |
| Standby ⁽²⁾ | V _{IH} | X | X | V _{CC} | V _{CC} ⁽²⁾ | High Z |
| Rapid Program ⁽³⁾ | V _{IL} | V _{IH} | Ai | V _{PP} | V _{CC} ⁽³⁾ | D _{IN} |
| PGM Verify ⁽³⁾ | X | V _{IL} | Ai | V _{PP} | V _{CC} ⁽³⁾ | D _{OUT} |
| Optional PGM Verify ⁽³⁾ | V _{IL} | V _{IL} | Ai | V _{CC} | V _{CC} ⁽³⁾ | D _{OUT} |
| PGM Inhibit ⁽³⁾ | V _{IH} | V _{IH} | X | V _{PP} | V _{CC} ⁽³⁾ | High Z |
| Product Identification ⁽³⁾⁽⁵⁾ | V _{IL} | V _{IL} | A9 = V _H ⁽⁴⁾ A0 = V _{IH} or V _{IL} A1 - A14 = V _{IL} | V _{CC} | V _{CC} ⁽³⁾ | Identification Code |

Notes: 1. X can be V_{IL} or V_{IH}.
 2. Read, output disable, and standby modes require, 2.7V ≤ V_{CC} ≤ 3.6V, or 4.5V ≤ V_{CC} ≤ 5.5V.
 3. Refer to Programming Characteristics. Programming modes require V_{CC} = 6.5V.
 4. V_H = 12.0 ± 0.5V.
 5. Two identifier bytes may be selected. All Ai inputs are held low (V_{IL}), except A9 which is set to V_H and A0 which is toggled low (V_{IL}) to select the Manufacturers' Identification byte and high (V_{IH}) to select the Device Code byte.



DC and AC Operating Conditions for Read Operation

| | | AT27BV256 | | | |
|------------------------------|------|--------------|--------------|--------------|--------------|
| | | -70 | -90 | -12 | -15 |
| Operating Temperature (Case) | Com. | 0°C - 70°C | 0°C - 70°C | 0°C - 70°C | 0°C - 70°C |
| | Ind. | -40°C - 85°C | -40°C - 85°C | -40°C - 85°C | -40°C - 85°C |
| V _{CC} Power Supply | | 2.7V to 3.6V | 2.7V to 3.6V | 2.7V to 3.6V | 2.7V to 3.6V |
| | | 5V ± 10% | 5V ± 10% | 5V ± 10% | 5V ± 10% |

DC and Operating Characteristics for Read Operation

| Symbol | Parameter | Condition | Min | Max | Units |
|--------------------------------------|---|---|-----------------------|-----------------------|-------|
| V_{CC} = 2.7V to 3.6V | | | | | |
| I _{LI} | Input Load Current | V _{IN} = 0V to V _{CC} | | ±1 | μA |
| I _{LO} | Output Leakage Current | V _{OUT} = 0V to V _{CC} | | ±5 | μA |
| I _{PP1} ⁽²⁾ | V _{PP} ⁽¹⁾ Read/Standby Current | V _{PP} = V _{CC} | | 10 | μA |
| I _{SB} | V _{CC} ⁽¹⁾ Standby Current | I _{SB1} (CMOS), $\overline{CE} = V_{CC} \pm 0.3V$ | | 20 | μA |
| | | I _{SB2} (TTL), $\overline{CE} = 2.0$ to V _{CC} + 0.5V | | 100 | μA |
| I _{CC} | V _{CC} Active Current | f = 5 MHz, I _{OUT} = 0 mA, $\overline{CE} = V_{IL}$, V _{CC} = 3.6V | | 8 | mA |
| V _{IL} | Input Low Voltage | V _{CC} = 3.0 to 3.6V | -0.6 | 0.8 | V |
| | | V _{CC} = 2.7 to 3.6V | -0.6 | 0.2 x V _{CC} | V |
| V _{IH} | Input High Voltage | V _{CC} = 3.0 to 3.6V | 2.0 | V _{CC} + 0.5 | V |
| | | V _{CC} = 2.7 to 3.6V | 0.7 x V _{CC} | V _{CC} + 0.5 | V |
| V _{OL} | Output Low Voltage | I _{OL} = 2.0 mA | | 0.4 | V |
| | | I _{OL} = 100 μA | | 0.2 | V |
| | | I _{OL} = 20 μA | | 0.1 | V |
| V _{OH} | Output High Voltage | I _{OH} = -2.0 mA | 2.4 | | V |
| | | I _{OH} = -100 μA | V _{CC} - 0.2 | | V |
| | | I _{OH} = -20 μA | V _{CC} - 0.1 | | V |
| V_{CC} = 4.5V to 5.5V | | | | | |
| I _{LI} | Input Load Current | V _{IN} = 0V to V _{CC} | | ±1 | μA |
| I _{LO} | Output Leakage Current | V _{OUT} = 0V to V _{CC} | | ±5 | μA |
| I _{PP1} ⁽²⁾ | V _{PP} ⁽¹⁾ Read/Standby Current | V _{PP} = V _{CC} | | 10 | μA |
| I _{SB} | V _{CC} ⁽¹⁾ Standby Current | I _{SB1} (CMOS), $\overline{CE} = V_{CC} \pm 0.3V$ | | 100 | μA |
| | | I _{SB2} (TTL), $\overline{CE} = 2.0$ to V _{CC} + 0.5V | | 1 | mA |
| I _{CC} | V _{CC} Active Current | f = 5 MHz, I _{OUT} = 0 mA, $\overline{CE} = V_{IL}$ | | 20 | mA |
| V _{IL} | Input Low Voltage | | -0.6 | 0.8 | V |
| V _{IH} | Input High Voltage | | 2.0 | V _{CC} + 0.5 | V |
| V _{OL} | Output Low Voltage | I _{OL} = 2.1 mA | | 0.4 | V |
| V _{OH} | Output High Voltage | I _{OH} = -400 μA | 2.4 | | V |

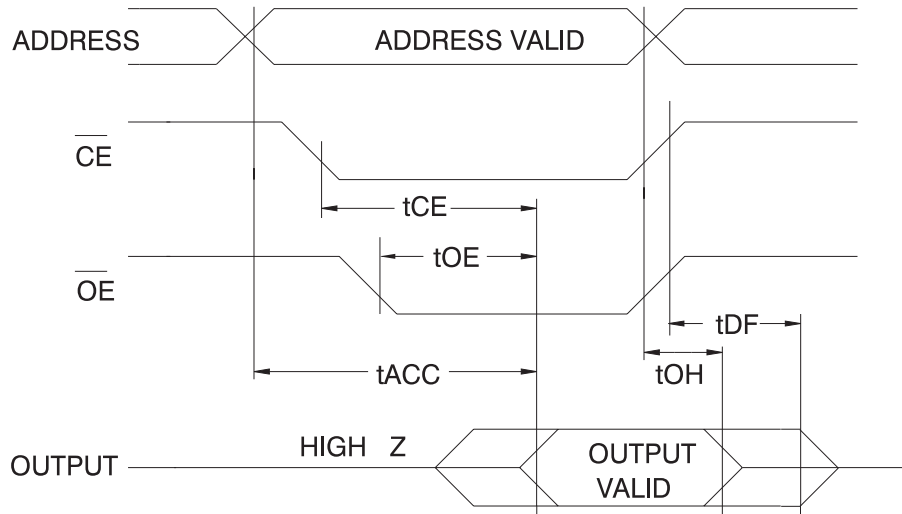
- Notes: 1. V_{CC} must be applied simultaneously with or before V_{PP} and removed simultaneously with or after V_{PP}
 2. V_{PP} may be connected directly to V_{CC}, except during programming. The supply current would then be the sum of I_{CC} and I_{PP}

AC Characteristics for Read Operation

$V_{CC} = 2.7V$ to $3.6V$ and $4.5V$ to $5.5V$

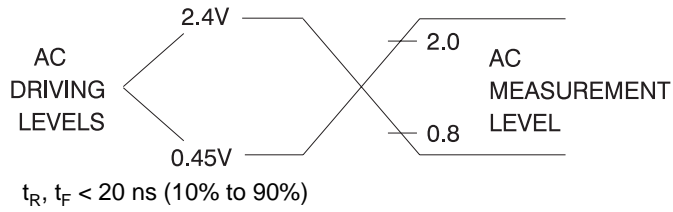
| Symbol | Parameter | Condition | AT27BV256 | | | | | | | | Units |
|-------------------|---|--|-----------|-----|-----|-----|-----|-----|-----|-----|-------|
| | | | -70 | | -90 | | -12 | | -15 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| $t_{ACC}^{(3)}$ | Address to Output Delay | $\overline{CE} = \overline{OE} = V_{IL}$ | | 70 | | 90 | | 120 | | 150 | ns |
| $t_{CE}^{(2)}$ | \overline{CE} to Output Delay | $\overline{OE} = V_{IL}$ | | 70 | | 90 | | 120 | | 150 | ns |
| $t_{OE}^{(2)(3)}$ | \overline{OE} to Output Delay | $\overline{CE} = V_{IL}$ | | 50 | | 50 | | 50 | | 60 | ns |
| $t_{DF}^{(4)(5)}$ | \overline{OE} or \overline{CE} High to Output Float, whichever occurred first | | | 40 | | 40 | | 40 | | 50 | ns |
| t_{OH} | Output Hold from Address, \overline{CE} or \overline{OE} , whichever occurred first | | 0 | | 0 | | 0 | | 0 | | ns |

AC Waveforms for Read Operation⁽¹⁾

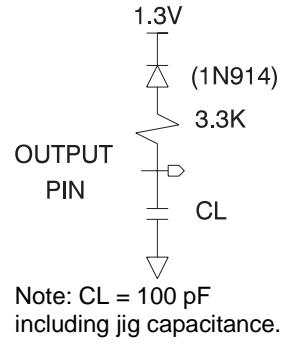


- Notes:
1. Timing measurement references are 0.8V and 2.0V. Input AC drive levels are 0.45V and 2.4V, unless otherwise specified.
 2. \overline{OE} may be delayed up to $t_{CE} - t_{OE}$ after the falling edge of \overline{CE} without impact on t_{CE} .
 3. \overline{OE} may be delayed up to $t_{ACC} - t_{OE}$ after the address is valid without impact on t_{ACC} .
 4. This parameter is only sampled and is not 100% tested.
 5. Output float is defined as the point when data is no longer driven.
 6. When reading a 27BV256, a 0.1 μF capacitor is required across V_{CC} and ground to suppress spurious voltage transients.

Input Test Waveform and Measurement Level



Output Test Load



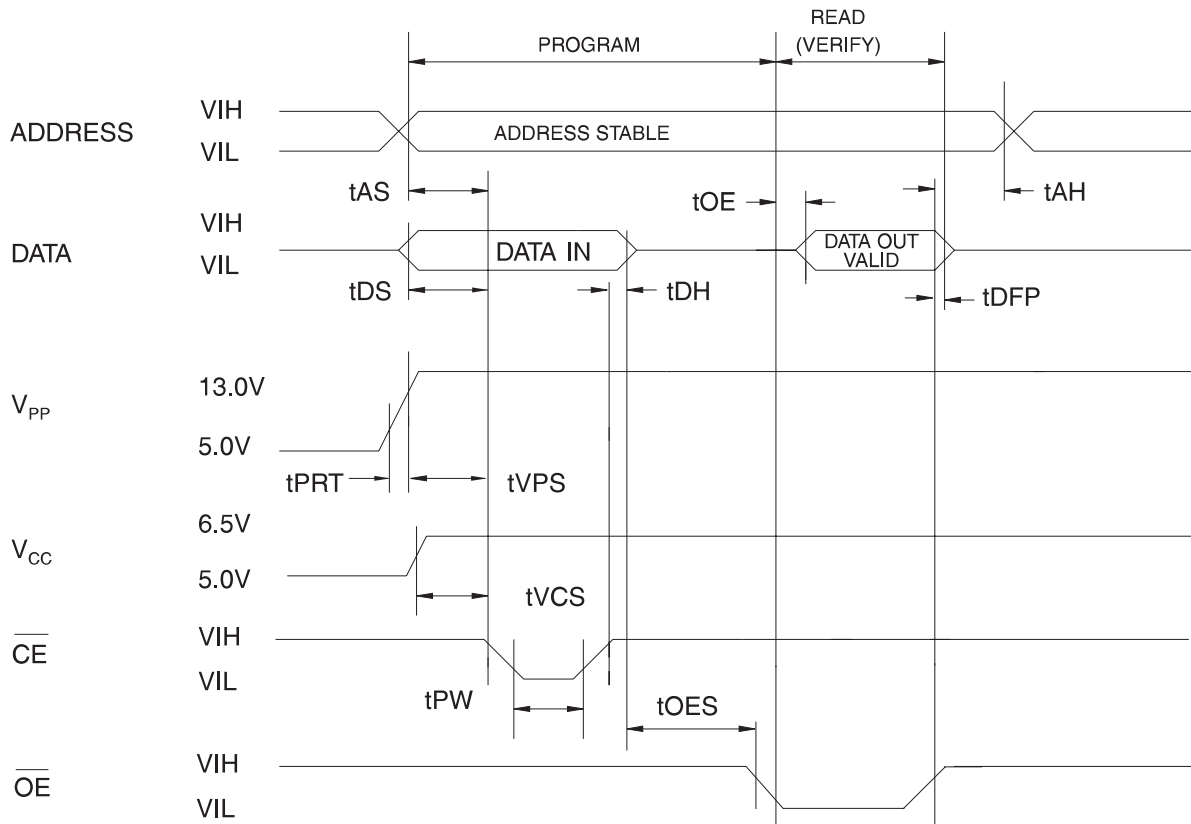
Pin Capacitance

$f = 1 \text{ MHz, } T = 25^\circ\text{C}^{(1)}$

| Symbol | Typ | Max | Units | Conditions |
|-----------|-----|-----|-------|----------------|
| C_{IN} | 4 | 8 | pF | $V_{IN} = 0V$ |
| C_{OUT} | 8 | 12 | pF | $V_{OUT} = 0V$ |

Note: 1. Typical values for nominal supply voltage. This parameter is only sampled and is not 100% tested.

Programming Waveforms⁽¹⁾



- Notes:
1. The Input Timing Reference is 0.8V for V_{IL} and 2.0V for V_{IH} .
 2. t_{OE} and t_{DFF} are characteristics of the device but must be accommodated by the programmer.
 3. When programming the AT27BV256 a 0.1 μF capacitor is required across V_{PP} and ground to suppress spurious voltage transients.

DC Programming Characteristics

$T_A = 25 \pm 5^\circ\text{C}$, $V_{CC} = 6.5 \pm 0.25\text{V}$, $V_{PP} = 13.0 \pm 0.25\text{V}$

| Symbol | Parameter | Test Conditions | Limits | | Units |
|-----------|--|-----------------------------|--------|----------------|---------------|
| | | | Min | Max | |
| I_{LI} | Input Load Current | $V_{IN} = V_{IL}, V_{IH}$ | | ± 10 | μA |
| V_{IL} | Input Low Level | | -0.6 | 0.8 | V |
| V_{IH} | Input High Level | | 2.0 | $V_{CC} + 0.5$ | V |
| V_{OL} | Output Low Voltage | $I_{OL} = 2.1 \text{ mA}$ | | 0.4 | V |
| V_{OH} | Output High Voltage | $I_{OH} = -400 \mu\text{A}$ | 2.4 | | V |
| I_{CC2} | V_{CC} Supply Current (Program and Verify) | | | 25 | mA |
| I_{PP2} | V_{PP} Current | $\overline{CE} = V_{IL}$ | | 25 | mA |
| V_{ID} | A9 Product Identification Voltage | | 11.5 | 12.5 | V |



AC Programming Characteristics

$T_A = 25 \pm 5^\circ\text{C}$, $V_{CC} = 6.5 \pm 0.25\text{V}$, $V_{PP} = 13.0 \pm 0.25\text{V}$

| Symbol | Parameter | Test Conditions ⁽¹⁾ | Limits | | Units |
|-----------|---|--|--------|-----|---------------|
| | | | Min | Max | |
| t_{AS} | Address Setup Time | Input Rise and Fall Times: (10% to 90%) 20 ns | 2 | | μs |
| t_{OES} | \overline{OE} Setup Time | | 2 | | μs |
| t_{DS} | Data Setup Time | | 2 | | μs |
| t_{AH} | Address Hold Time | Input Pulse Levels: 0.45V to 2.4V | 0 | | μs |
| t_{DH} | Data Hold Time | | 2 | | μs |
| t_{DFP} | \overline{OE} High to Output Float Delay ⁽²⁾ | | 0 | 130 | ns |
| t_{VPS} | V_{PP} Setup Time | Input Timing Reference Level: 0.8V to 2.0V | 2 | | μs |
| t_{VCS} | V_{CC} Setup Time | | 2 | | μs |
| t_{PW} | \overline{CE} Program Pulse Width ⁽³⁾ | Output Timing Reference Level: 0.8V to 2.0V | 95 | 105 | μs |
| t_{OE} | Data Valid from \overline{OE} ⁽²⁾ | | | 150 | ns |
| t_{PRT} | V_{PP} Pulse Rise Time During Programming | | 50 | | ns |

- Notes:
- V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP} .
 - This parameter is only sampled and is not 100% tested. Output Float is defined as the point where data is no longer driven—see timing diagram.
 - Program Pulse width tolerance is $100 \mu\text{sec} \pm 5\%$.

Atmel's 27BV256 Integrated Product Identification Code⁽¹⁾

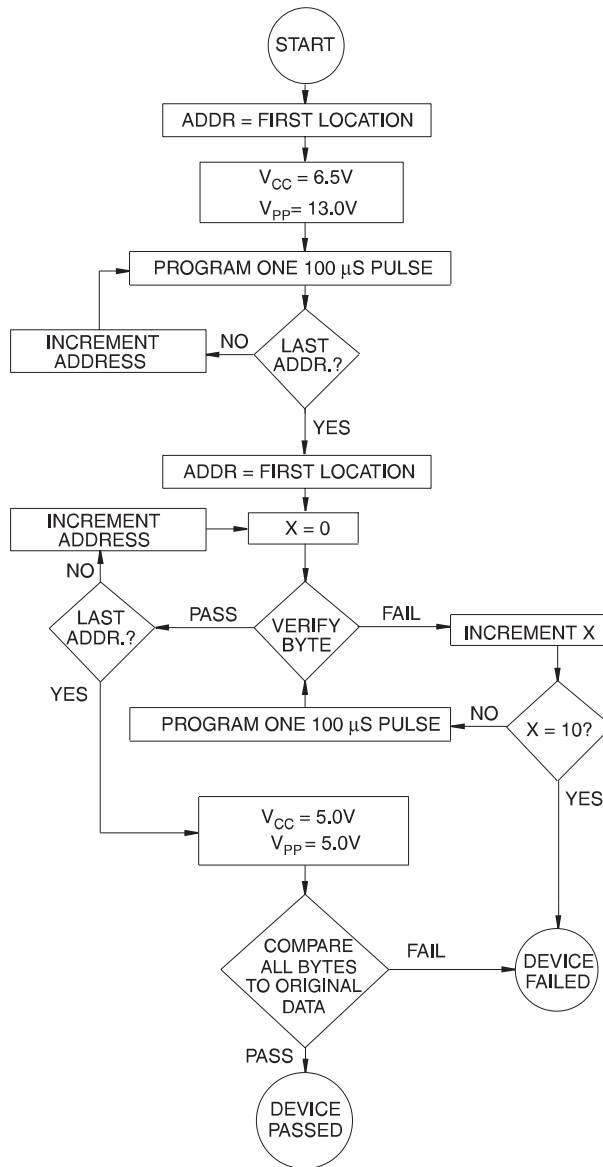
| Codes | Pins | | | | | | | | | Hex Data |
|--------------|------|----|----|----|----|----|----|----|----|----------|
| | A0 | O7 | O6 | O5 | O4 | O3 | O2 | O1 | O0 | |
| Manufacturer | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | 1E |
| Device Type | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 8C |

- Note:
- The AT27BV256 has the same Product Identification Code as the AT27C256R and AT27LV256A. They are all programming compatible.

Rapid Programming Algorithm

A 100 μs $\overline{\text{CE}}$ pulse width is used to program. The address is set to the first location. V_{CC} is raised to 6.5V and V_{PP} is raised to 13.0V. Each address is first programmed with one 100 μs $\overline{\text{CE}}$ pulse without verification. Then a verification/reprogramming loop is executed for each address. In the event a byte fails to pass verification, up to 10 successive 100 μs pulses are applied with a verification after each

pulse. If the byte fails to verify after 10 pulses have been applied, the part is considered failed. After the byte verifies properly, the next address is selected until all have been checked. V_{PP} is then lowered to 5.0V and V_{CC} to 5.0V. All bytes are read again and compared with the original data to determine if the device passes or fails.





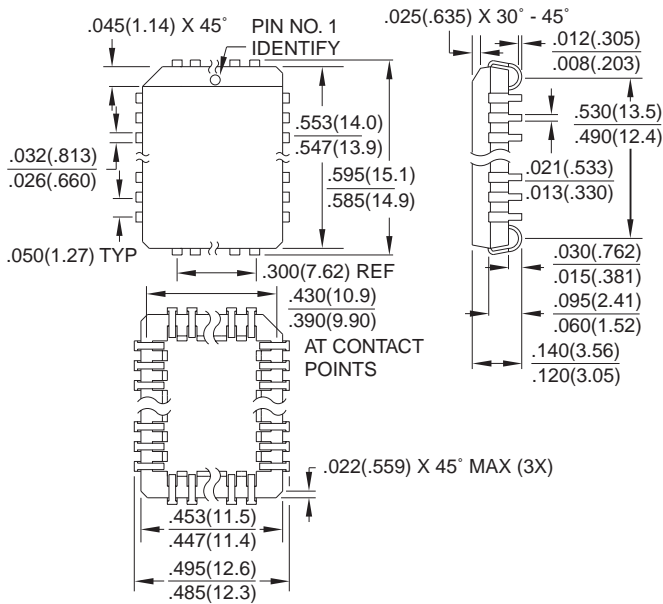
Ordering Information

| t _{ACC} (ns) | I _{CC} (mA) | | Ordering Code | Package | Operation Range |
|--------------------------|----------------------|---------|--|-------------------|-------------------------------|
| | Active | Standby | | | |
| 70 | 8 | 0.02 | AT27BV256-70JC AT27BV256-70RC AT27BV256-70TC | 32J 28R 28T | Commercial (0°C to 70°C) |
| | 8 | 0.02 | AT27BV256-70JI AT27BV256-70RI AT27BV256-70TI | 32J 28R 28T | Industrial (-40°C to 85°C) |
| 90 | 8 | 0.02 | AT27BV256-90JC AT27BV256-90RC AT27BV256-90TC | 32J 28R 28T | Commercial (0°C to 70°C) |
| | 8 | 0.02 | AT27BV256-90JI AT27BV256-90RI AT27BV256-90TI | 32J 28R 28T | Industrial (-40°C to 85°C) |
| 120 | 8 | 0.02 | AT27BV256-12JC AT27BV256-12RC AT27BV256-12TC | 32J 28R 28T | Commercial (0°C to 70°C) |
| | 8 | 0.02 | AT27BV256-12JI AT27BV256-12RI AT27BV256-12TI | 32J 28R 28T | Industrial (-40°C to 85°C) |
| 150 | 8 | 0.02 | AT27BV256-15JC AT27BV256-15RC AT27BV256-15TC | 32J 28R 28T | Commercial (0°C to 70°C) |
| | 8 | 0.02 | AT27BV256-15JI AT27BV256-15RI AT27BV256-15TI | 32J 28R 28T | Industrial (-40°C to 85°C) |

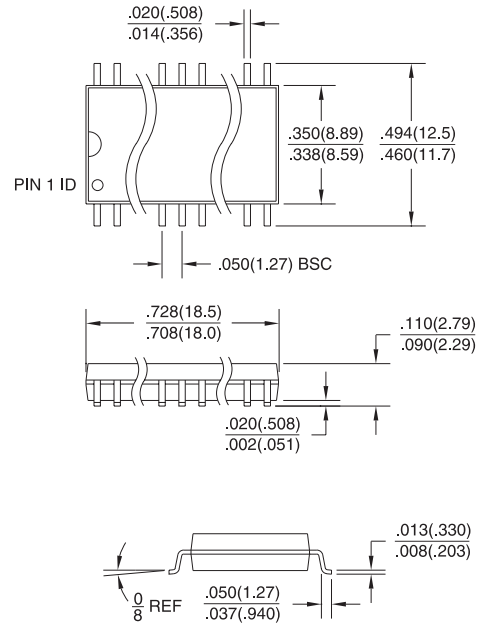
| Package Type | |
|--------------|--|
| 32J | 32-Lead, Plastic J-Leaded Chip Carrier (PLCC) |
| 28R | 28-Lead, 0.330" Wide, Plastic Gull Wing Small Package (SOIC) |
| 28T | 28-Lead, Plastic Thin Small Outline Package |

Packaging Information

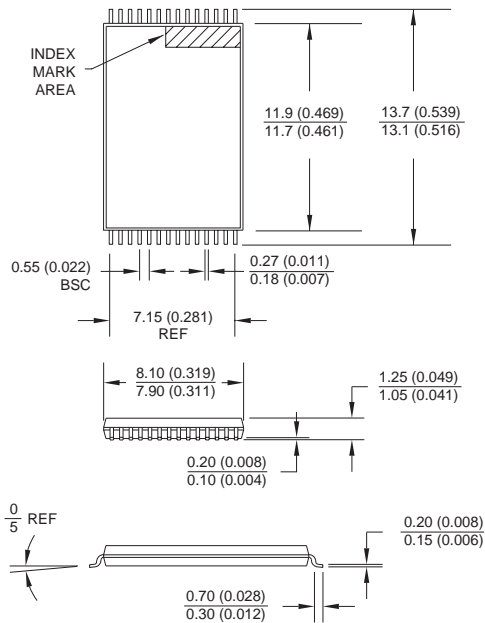
32J, 32-Lead, Plastic J-Leaded Chip Carrier (PLCC)
 Dimensions in Inches and (Millimeters)
 JEDEC STANDARD MS-016 AE



28R, 28-Lead, 0.330" Wide, Plastic Gull Wing Small Outline (SOIC)
 Dimensions in Inches and (Millimeters)



28T, 28-Lead, Plastic Thin Small Outline Package (TSOP)
 Dimensions in Millimeters and (Inches)*



*Controlling dimension: millimeters



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- ✓ Alternative Solution
- ✓ Excess Inventory Management